

DIGITAL FORENSIC RESEARCH CONFERENCE

Forensic Analysis of Water Damaged Mobile Devices

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Data Recovery from Damaged Devices

- Physical damage
- Fire damage
- Water damage





Data recovery is possible through chip transplant as long as the key components are undamaged

How We Receive Water Damaged Devices (In reality)

• Transported in liquid or in a dried state

(after being left at a police station for a few days ...)

- Disassembling
- PCB cleaning
- Drying



What are those white contaminants? Chip transplants really necessary?

Brief Summary of the Paper

• Our Goal:

- Understand the board level reaction when a mobile device contacts with liquid
- Update the forensic handling method for water damaged devices to improve successful data recovery

• Our findings:

- <u>Metal corrosion</u> is the key about water damaged devices
- Longer submersion time leads to more severe corrosion

Talk Outline

- Metal corrosion under humid environment
 - Electrochemical migration (ECM)
 - Galvanic corrosion
- Testing water damage to smartphones
 - Observing system failure of water-submerged smartphones
 - Repairing water damaged smartphones
- Conclusion

Smartphone Main Board





Inter-electrode reaction $Cu(OH)_2 \rightleftharpoons CuO + H_2O \rightleftharpoons Cu^{2+} + 2OH^-$









Metal Corrosion by ECM



Galvanic Corrosion



Galvanic Corrosion - Example



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Testing water damage on Smartphones

- Samsung Galaxy 6s Edge & LG Nexus 5X
 - Two each, one submerged while running, another while turned off
 - Battery fully charged
 - Left in tap water for three days





Results

After being dried and PCB cleaned

	Samsung S6 edge	LG Nexus 5
Turned on	PMIC damaged, swap needed	Display connector corroded
Turned off	PMIC short circuited no swap needed	No repair needed after cleaning

Results





LG display connector ~20V applied when display is working



LG Devices: Underfill protected



Samsung: no underfill



LG: Underfill protected²¹

Metal Corrosion and Missing Components by Galvanic corrosion



Longer submersion time = severe corrosion = detachment of components

Conclusions

- Water damage = Metal corrosion (ECM/Galvanic)
 = System failure
- Corrosion severity factors
 - Liquid conductivity
 - Submersion time
 - Exposure of metal
 - State of the device
 - Voltage level
- Proper knowledge about water damage helps successful data retrieval





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